

For instance, BP Solar used plating metallization in its Saturn technology® from the early 1990s, 30 based on the UNSW buried contacts. 31 Suntech's Pluto solar cell technology also incorporated the plating technology and was scaled to 500 MW from 2009 to 2013. 29 In addition, plated contacts have been used by SunPower in their IBC solar cells ...

This paper offers a detailed review and understanding of a Ni/Cu based plating technique for silicon solar cells. The formation of a Ni seed layer by adopting various deposition techniques and a Cu conducting layer using a light induced plating (LIP) process are appraised. Unlike screen-printed metallization, a step involving patterning is ...

Inkjet printing offers low-cost and high-precision processing for application of an appropriate plating resist. It covers the solar cell's front side with narrow openings for subsequent ...

Figure 1. Schematic structures of solar cells composed of metal contacts formed with screen-printed Ag paste (left) and Ni/Cu plating (right). Considering the higher cost of Ag and tarnished cell parameters due to shading losses and lower FFs, screen-printed contacts offer an opportunity for replacement by an alternate metallization.

Copper plating is of great interest and regarded as an ideal alternative electrode solution and industrially proven technology for diffused-emitter solar cell [[11], [12], [13]] nefited from the copper"s high conductivity and thin finger width, the shading loss and finger resistance can be reduced remarkably, which can enhance the electrical properties.

Despite its more complex processing sequence, copper plating for solar cells was already successful for large-scale PV production by BP Solar, Tetrasun, Suntech, SunPower, or GS Solar. SHJ solar cells which require the most silver per Watt and suffer from poor conductivity of the low temperature silver pastes would yield the greatest cost ...

The solar cell used is a standard InGaP/InGaAs/Ge tri-ple-junction solar cell grown by MOCVD on a Ge sub-strate. Solar cell dimensions were 7.648*6.648 mm2 with a front emitter contact pattern with 56 fingers with a pitch of 120 mm. GaAs contact layer of the solar cell was etched using a NH 4OH:H 2O 2:H 20 solution in a self-aligned process. The

Copper plating metallization is growing in importance to replace silver and to enable growth of photovoltaic to terawatt-scale. Besides better performance of the plated Cu contacts on solar cells ...

Conclusion and outlook In this paper, we have presented a new plating process for silicon heterojunction solar cells using selective plating onto a laser transferred seed layer on a full area PVD conductive mask layer. Pulse reverse current plating was used to minimize parasitic plating effectively on the mask layer. The benefit of



using Al as ...

The proof of concept of a novel metallization route for bifacial silicon heterojunction (SHJ) solar cells by selective plating - i.e. organic mask-free, is demonstrated by a first lab scale ...

Front and rear side contact TOPCon solar cells with plated Ni/Cu/Ag metallization on the TOPCon layer showed the feasibility of the plating process allowing efficiencies up to 22.7 % with FF = 82. ...

ABSTRACT: Copper plating metallization is growing in importance to replace silver and to enable growth of photovoltaic to terawatt-scale. Besides better performance of the plated Cu contacts on solar cells, the processing needs ... SHJ solar cells using the selective laser patterning of Al. multiple laser pulses on the same 3 layer bit by bit ...

In order to investigate the effect of contact resistance on the solar cells parameters according to the current density of the Cu-Ni alloy plating, the SHJ solar cells with 4 cm 2 cell area in group 2 were measured ...

Bifacial (BF) copper-plated crystalline silicon solar cell is an attractive topic to concurrently reduce silver consumption and maintain good device performance. However, it is still challenging to...

Passivated-contact solar cell designs, such as TOPCon or silicon heterojunction solar cells (SHJs), enable cell efficiencies greater than 24%, and are promising candidates for the next revolution ...

Crystalline silicon (c-Si) heterojunction (HJT) solar cells are one of the promising technologies for next-generation industrial high-efficiency silicon solar cells, and many efforts in transferring this technology to high-volume manufacturing in the photovoltaic (PV) industry are currently ongoing. Metallization is of vital importance to the PV performance and ...

Solar Plating. Meco has some exiting product lines for solar cell manufacturing, meeting the needs for lower cost and higher cell efficiency. Meco DPL . For next generation silicon solar cells where the SiNx layer has been opened by laser ablation the Meco Direct Plating Line (DPL) can plate a dense layer of Ni-Ag, Ni-Cu-Ag or Ni-Cu-Sn onto ...

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The challenges for copper metallization process of SHJ solar cell are mainly the selective plating on TCO film and adhesion between plated finger and metal oxide layer. The conventionally plating process sequence involves five steps (shown in Fig. 3): (1) Full area seed layers are usually deposited by physical vapor deposition (PVD) or ...

Solar photovoltaics (PV) is one of the most promising clean and sustainable energy sources. The PV market



has been steadily grown over the last few decades and continuous dominated by silicon, with the record cell efficiency over 26% recently reported [1].Moreover, the price of electricity from large-scale photovoltaic power plants is already ...

A review of modern Cu plating technologies for solar cells can be found elsewhere [9]. Plating for SHJ cells differs from plating for diffused cells in two main aspects. First, in SHJ cells metal ...

The dielectric plating mask remains on the cell. Parasitic plating is prevented by using an advanced reverse pulse plating process. With the first solar cells we reach a maximum efficiency of 22.2% and an efficiency gain of 0.5% abs compared to low-temperature screen printing reference cells, due to a higher short circuit current and fill factor.

For the reduction of optical loss and contact material cost in silicon heterojunction (SHJ) solar cells, copper plating has been considered as a suitable metallization technique. However, a plated ...

Passivated-contact solar cell designs, such as TOPCon or silicon heterojunction solar cells (SHJs), enable cell efficiencies greater than 24%, and are promising candidates for the next...

bifacially printed TOPCon solar cells and agrees well with literature data from Kaule et al. [11]. This shows that the applied plating process for bifacial TOPCon solar cells did not increase the risk of wafer breakage compared to screen printed TOPCon solar cells or state-of-the-art PERC solar cells. Single cell modules without glass but with ...

Electroplating of Ni/Cu/Ag contacts was found to be a suitable candidate to metallize bifacial TOPCon solar cells. 13, 14 Plating is a lead-free metallization technique which allows narrow contact geometries (<25 mm) and low contact resistivities (r c < 1 mOcm 2). 13, 15 A recent publication by Kluska 16 presented module manufacturing of ...

The formation of a Ni seed layer by adopting various deposition techniques and a Cu conducting layer using a light induced plating (LIP) process are appraised and a step involving patterning is crucial for opening the masking layer. Developing a better method for the metallization of silicon solar cells is integral part of realizing superior efficiency. Currently, ...

The current-voltage (I-V) characteristics of the solar cells were measured with a shadow mask (5 × 5 mm 2 opening) to define the active cell area. After Cu plating, the cells were stored in argon atmosphere and measured 7 days ...

In order to investigate the effect of contact resistance on the solar cells parameters according to the current density of the Cu-Ni alloy plating, the SHJ solar cells with 4 cm 2 cell area in group 2 were measured by using an in-house solar simulator. As a reference, a solar cell which has metal contacts with an evaporated copper seed layer ...



Plating metallization for TOPCon solar cells Bifacially plated Ni/Cu/Ag metal contacts can help to further reduce manufacturing costs and increase the cell efficiency of industrial TOPCon (i-TOPCon)

This paper reports on the evolution of metal plating techniques, from their use in early silicon solar cells, to current light-induced plating processes. Unlike screen-printed metallisation, metal plating typically requires an initial patterning step to create openings in a masking layer for the subsequent self-aligned metallisation.

25.54% on commercial-sized SHJ solar cell with Ag-free Cu met-allization technology (monofacial [MF] or BF solar cell design unknown).[8] To realize a BF plating process, the approach can be realized in a 2-step process, that is, first do plating on one side of the wafer (with the other side protected or biased) and then plate on the other side.

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